

60V, 5A, Synchronous Buck Converter

1 Features

- 12V to 60V wide operating input range
- 5A continuous output current capability
- Integrated 60V, $20m\Omega$ high side and 60V, $20m\Omega$ low side power MOSFET switches
- Adjustable Frequency from 50kHz to 500kHz Operation
- Precision Reference Voltage (1.2 V)
- Programmable Soft-Start with Pre-biased Load Capability
- Programmable EN Off Delay Function
- Programmable Over-Load Protection with 0.2S blank timer and Hiccup
- Programmable Cycle-by-Cycle Current Limiting Protection
- Programmable Input Under-Voltage Lockout Protection with Latch
- Programmable Input Over-Voltage Protection with Latch
- Output Over-Voltage Protection
- Over-Temperature Protection
- QFN5*5mm-32L

2 Applications

- 48 V Non-Isolated DC-DC Converter
- Car applications
- Telecom Bus Converters
- General purpose
- USB Type-C Power Delivery
- Industrial DC-DC Motor Drivers

3 Description

PL86051 is a high voltage Buck Converter designed for high performance synchronous Buck DC/DC applications with input voltages up to 60V.

PL86051 integrates a high efficiency synchronous step-down switching regulator, which includes a 60V, $20m\Omega$ high side and a 60V, $20m\Omega$ low side MOSFETs to provide 5A continuous load current over12V to 60V wide operating input voltage.

PL86051 switching frequency is programmable from 50 kHz up to 500 kHz allowing the flexibility to tune for efficiency and size. The output voltage can be precisely regulated using the internally 1.2 V reference voltage for low voltage applications.

Protection features include user programmable under voltage lockout, over voltage lockout and over current protection. The supply current drops below 20µA in shutdown mode. PL86051 is a good choice for car infotainment application, telecom bus converter, etc.

4 Typical Application Schematic

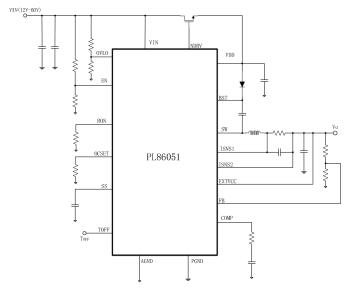


Fig. 1 Application Schematic



5 Pin Configuration and Functions

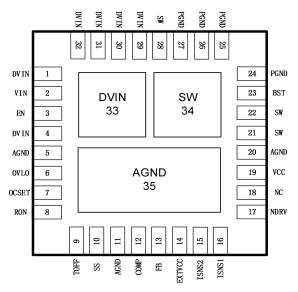


Fig. 2

Pin			
Name Number		Description	
VIN	2	Analog Input voltage.	
EN	3	Enable pin.	
DVIN	1,4,29,30, 31,32,33	Power Input voltage.	
PGND	24,25,26, 27	Power Ground. This pin serves as a separate ground for the MOSFET driver and should be connected to the system's power ground plane.	
OVLO	6	An external voltage divider is used to set the over voltage threshold levels.	
OCSET	7	Current limit set point. A resistor from this pin to GND will set the positive and negative current limit threshold.	
RON	8	Connect this pin to GND by a resistor to set the switching frequency.	
TOFF	9	This pin provides user programmable shutdown delay time function. Connect to GND: No Delay Connect to VCC: 20S Floating: 10S	
ss	10	This pin provides user programmable soft–start function. External capacitor connected from this pin to ground sets the startup time of the output voltage.	
AGND	5,11,20,35	Signal ground for internal reference and control circuitry.	
COMP	12	Output of error amplifier. An external resistor and capacitor network is typically connected from this pin to ground to provide loop compensation.	
FB 13		Feedback Input. FB senses the output voltage. Connect FB with a resistor divider connected between the output and ground. FB is a sensitive node. Keep FB away from noisy signal, such as SW and BST pin.	
EXTVCC	14	External Power Input to an Internal LDO linear regulator Connected to VCC. This LDO supplies VCC power from EXTVCC, bypassing the external NDRV LDO whenever EXTVCC is higher than 10V. Do not exceed 30V on this pin. Do not connect EXTVCC to a voltage greater than VIN. Connect to GND if not used.	
ISNS2	15	Inductor current sense input 2.	
ISNS1	16	Inductor current sense input 1.	
NDRV	17	Drive Output for External Pass Device of the NDRV LDO Linear Regulator for VCC. Connect this pin to the gate of an external NMOS or NPN pass device.	
		This pin provides power for the internal blocks of the IC. A minimum of 4.7uFcapacitor must be connected from this pin to ground.	
SW	21,22,28,34	Switch Node. Connect this pin to the switching node of inductor.	
BST	23	This pin powers the high side driver and must be connected to a voltage higher than input voltage. A minimum of 0.1uF, high frequency capacitor must be connected from this pin to switch node.	
NC	NC 18 Not Connected.		



6 Device Marking Information

Part Number	Order Information	Package	Package Qty	Top Marking
PL86051	PL86051IQN32	QFN5x5 - 32	5000	86051 RAAYMD

PL86051: Part Number

RAAYMD: RAA: LOT NO.; YMD: Package Date Code



7 Specifications

7.1 Absolute Maximum Ratings(Note1)

	PARAMETER	MIN	MAX	Unit
	V _{IN} to GND	-0.3	60	
	V _{FB} , V _{OVLO} , V _{UVLO} to GND	-0.3	6	
Input Voltages	V _{TOFF} to GND	-0.3	12] ,
Input Voltages	V _{ISNS1,2} to GND	-0.3	60]
	V _{EN} to GND	-0.3	60	
	V _{IN} to GND -0.3 V _{FB} , V _{OVLO} , V _{UVLO} to GND -0.3 V _{TOFF} to GND -0.3 V _{ISNS1,2} to GND -0.3 V _{EN} to GND -0.3 V _{EXTVCC} to GND -0.3 V _{CC} to GND -0.3 V _{RON} , V _{OCSET} , V _{SS} , V _{COMP} to GND -0.3 V _{BST} to V _{SW} -0.3	30		
Output Voltages	V _{VCC} to GND	-0.3	12	
	V _{RON} , V _{OCSET} , V _{SS} , V _{COMP} to GND	-0.3	6	,
	V _{BST} to V _{SW}	-0.3	12]
	V _{SW} to GND	-3	V _{IN} + 0.3	

7.2 Handling Ratings

PARAMETER	DEFINITION	MIN	MAX	UNIT
T _{ST} Storage Temperature Range		-65	150	°C
TJ	Junction Temperature		+150	°C
T∟	Lead Temperature		+260	°C
V _{ESD}	HBM Human body model		2	kV
	CDM Charger device model		500	V

7.3 Recommended Operating Conditions (Note 2)

	PARAMETER	MIN	MAX	Unit	
	V _{IN} to GND	12	60		
	V _{FB} , V _{OVLO} , V _{UVLO} to GND	-0.3	5		
Innut \/altagaa	V _{TOFF} to GND	-0.3	10	\ \ \	
Input Voltages	V _{ISNS1,2} to GND	-0.3	60	\ \ \	
	V _{EN} to GND	-0.3	60		
	V _{EXTVCC} to GND	-0.3	30		
Output Voltages	V _{VCC} to GND	-0.3	10		
	V _{RON} , V _{OCSET} , V _{SS} , V _{COMP} to GND	-0.3	5	\ \ \	
Output voitages	VFB, VOVLO, VUVLO to GND -0.3 5 VTOFF to GND -0.3 10 VISNS1,2 to GND -0.3 60 VEN to GND -0.3 60 VEXTVCC to GND -0.3 30 VVCC to GND -0.3 10 VRON, VOCSET, VSS, VCOMP to GND -0.3 5 VBST to VSW -0.3 10 VSW to GND -3 VIN+0.3	V			
	V _{SW} to GND	VuvLo to GND			
Temperature	Operating junction temperature range, T _J	-40	+125	°C	

7.4 Thermal Information(Note 4)

Symbol	Description	QFN5x5 - 32	Unit	
θ_{JA}	Junction to ambient thermal resistance	40	°C/W	
θ _{JC}	Junction to case thermal resistance	23	C/VV	

- 1) Exceeding these ratings may damage the device.
 2) The device function is not guaranteed outside of the recommended operating conditions.
 3) Measured on approximately 1" square of 1 oz copper.



7.5 Electrical Characteristics(Typical at Vin = 12V, T_J=25°C, unless otherwise noted.)

SYMBOL	PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
VIN	Input Supply Operating Voltage Range		12		60	V
VOUT	Regulated Output Voltage Set Point		1.2		48	V
MOSFET		- 40 \/ - 5\/				
R _{DS(ON)_H} R _{DS(ON)_L}	High-Side Switch On-Resistance Low-Side Switch On-Resistance	$I_{OUT} = 1A, V_{OUT} = 5V$ $I_{OUT} = 1A, V_{OUT} = 5V$		20 20		mΩ mΩ
` /-	CE VOLTAGE	1001 - 1A, V001 - 3V		20		111122
KEFEKEN	CE VOLTAGE	On and a ser MED 4 05M	1			
IQ	Statics Current	Open Loop, VFB = 1.25V, No Switching, VIN=48V , TJ=25℃		400		uA
I _{SHUTDOWN}	EN Shutdown Supply Current	Close Loop, VEN=0V, VIN=48V		20		
REFEREN	CE VOLTAGE					
	Feedback Voltage			1.2		Ιv
V_{FB}	Accuracy		-1.5		+1.5	%
CLIDDI V V	OLTAGE (Vcc)		1.0		. 1.0	1 /0
SUPPLI V	OLIAGE (VCC)	Supply by NDRV LDO	9	9.5	10	ΙV
VCC	V _{VCC} Regulator Output	Supply by RDRV LDO Supply by EXTVCC LDO	9.5	10	10.5	V
UNDERVO	LTAGE LOCKOUT	1 PP1, -, -// 100 -D0	1 0.0		10.0	I *
V _{VCC_UVLO}	V _∞ Under Voltage Lockout Voltage(V _∞ increasing)	-40°C≤ T _J ≤ 125°C		8		V
V _{VCC} _ UVLOH	V _{cc} Under Voltage Hysteresis			670		mV
V_{BST_UVLO}	V _{BST} Under Voltage Lockout Voltage(V _{BST} increasing)	-40°C≤ T _J ≤ 125°C		5.6		V
V _{BST} _ UVLOH	V _{BST} Under Voltage Hysteresis			860		mV
V _{IN_UVLO}	VIN Under Voltage Lockout Voltage(V _{IN} increasing)			6.5		V
V_{IN_UVLOH}	VIN Under Voltage Hysteresis			650		mV
V _{EN_UVLO}	EN Under Voltage Lockout Voltage(V _{EN} increasing)			1.2		V
V _{EN_UVLOH}	EN Under Voltage Hysteresis			200		mV
OVER VOL	TAGE LOCKOUT					
REF _{IN_OVP}	Reference of VIN Over Voltage Lockout Voltage(V _{IN} increasing)		1.176	1.2	1.224	V
HYS _{IN_OVP}	Reference Hysteresis of VIN Over Voltage Lockout Voltage			200		mV
CONTROL	LOOP					
I(Source/ Sink)	Source/Sink Current			300		uA
gm	Trans-conductance			3		mS
SOFT-STA	ART					
I _{SS}	Soft-Start Current	SS = 0 V	15	20	25	uA
VSNS LIMI	Т					
Vocset	OCSET voltage	-40°C≤ T _J ≤ 125°C		1.2		V
VLIMH	On Duty ISNS1-ISNS2 Limit	R _{OCSET} = 25k Ohm, VLIMH=1.2/R _{OCSET} *25K/10		120		mV
VLIML	Off Duty ISNS1-ISNS2 Limit	R _{OCSET} = 25k Ohm, VLIML=1.2/R _{OCSET} *20K/10		96		mV
T _{OVERLOAD}	Over Load Protection Blank Time	. 55521 =		200		ms
Frequency		<u> </u>	<u> </u>			ı .
		F V4//DL *500 \		000		
F _{SW}	Switching Frequency	Fsw=Vout/(Rh*500p) Or Fsw=1/(RL*50p)	50	200	500	kHz



TON _{MIN}	Minimum On Time		140	ns			
TOFF _{MIN}	Minimum Off Time		400	ns			
Toff Timer							
	Toff Time Delay	Toff = GND	0	s			
T _{OFF}		Toff = Float	10	s			
		Toff = VCC	20	S			
OUTPUT D	OUTPUT DRIVERS						
Tdelay1	Top Gate Off to Bottom Gate On Delay		70	ns			
Tdelay2	Bottom Gate Off to Top Gate On Delay		70	ns			

Note:4) Guaranteed by design, not tested in production.



8 Typical Characteristics

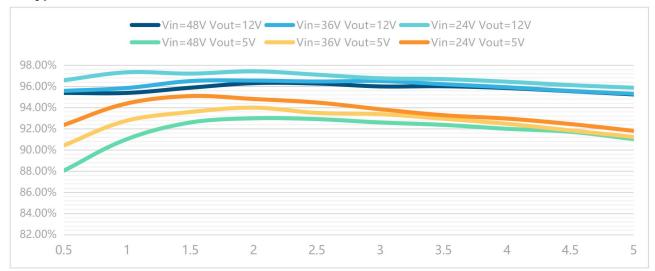
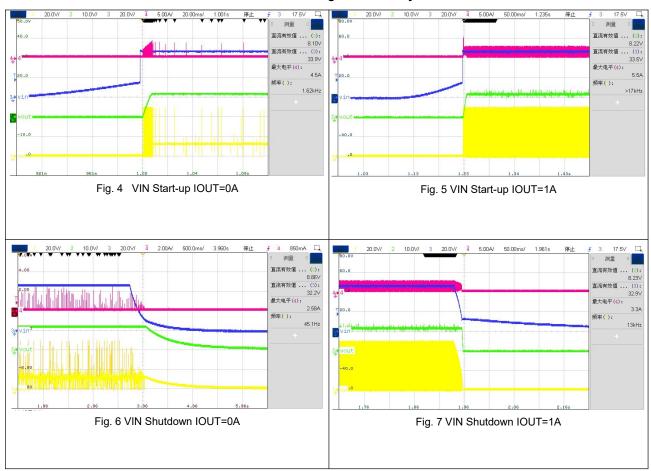
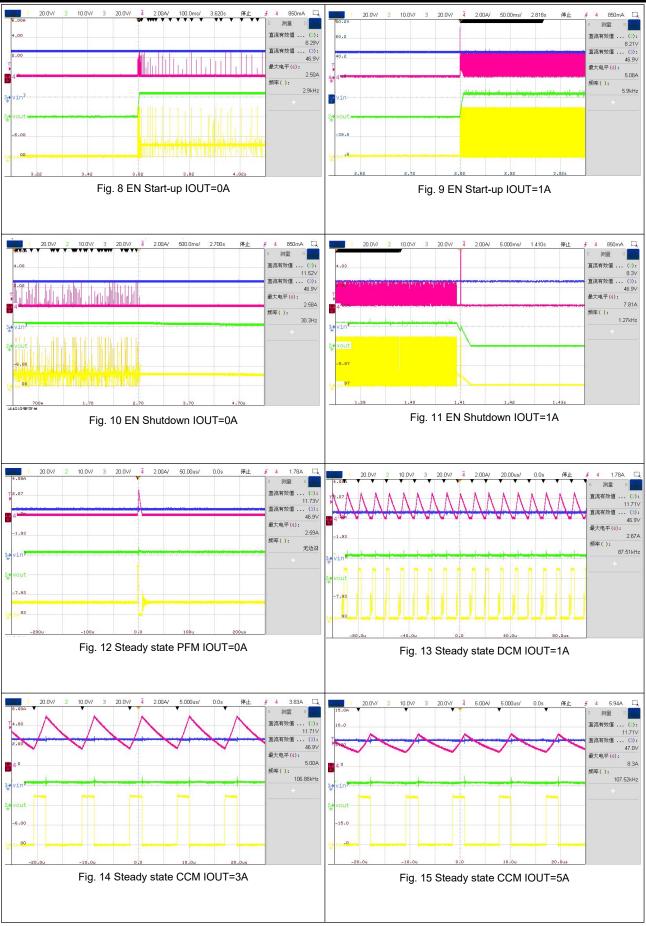


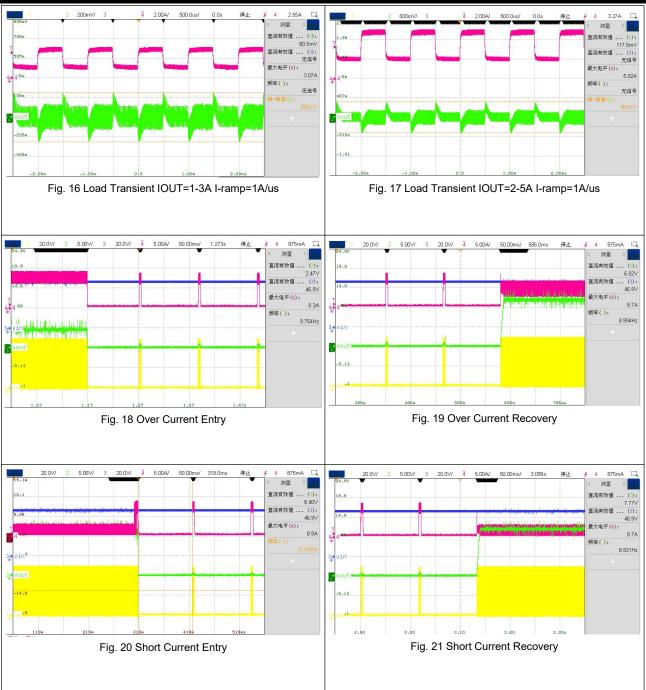
Fig. 3 Efficiency













9 Detailed Description

9.1 Overview

PL86051 is a high voltage Buck Converter designed for high performance synchronous Buck DC/DC applications with input voltages up to 60V.

PL86051 integrates a high efficiency synchronous step-down switching regulator, which includes a 60V, $20m\Omega$ high side and a 60V, $20m\Omega$ low side MOSFETs to provide 5A continuous load current over 12V to 60V wide operating input voltage. The PL86051 adopts adaptive constant on time peak current mode control at the moderate to heavy load currents and operates in the PFM mode at the light load current. With this control scheme, the PL86051 provides the excellent line and load transient response with the minimal output capacitor. The external loop compensation brings the flexibility to use a wider range of the inductor and output capacitor combinations.

The PL86051 supports the adjustable switching frequency up to 500kHz. This device implements user programmable cycle-by-cycle current limit with 200ms over load timer to protect the device from thermal run away. If the overload condition or short circuit protection is triggered, enter hiccup mode until the fault is removed. This device also implements user programmable over voltage lockout protection and over temperature protection to ensure reliably operation.

9.2 Functional Block Diagram

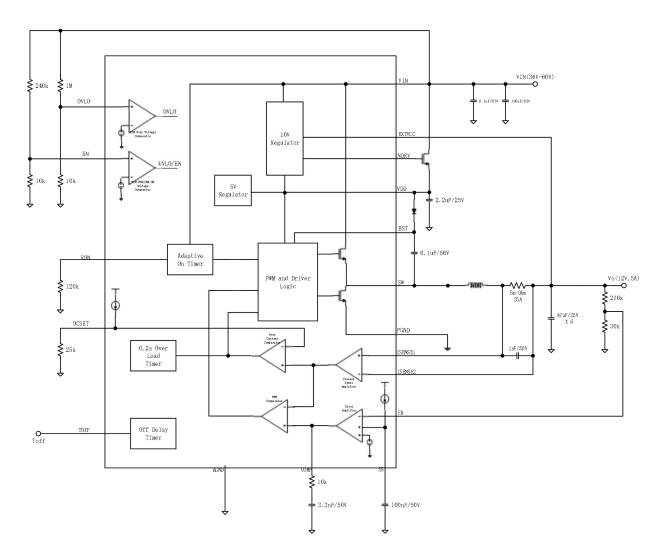


Fig. 22 Functional Block Diagram



9.3 Feature Description

9.3.1 Enable and OVLO

When the EN pin is pulled high above 1.2V, this part is enabled. When the EN pin is pulled below 1.0V, this part goes into the shutdown mode and stops operation.

When the OVLO pin is pulled high above 1.2V, the PL86051 is disabled and it will not resume switching even if OVLO falls below 1.0V unless EN is toggled.

9.3.2 Under-voltage Lockout

This controller stops switching when the input voltage drops below 5.85V or VCC is below 7.33V. It resumes operation when input voltage is larger than 6.5V and VCC is larger than 8V.

9.3.3 Cycle-by-Cycle Current Limit and Over Load Protection

The PL86051 provides cycle-by-cycle current limit to protect power MOSFET during on duty and also off duty. It will immediately turn off high side MOSFET once on duty current limit is triggered or prolongs the off duty until the inductor current is lower than off duty current limit. Hiccup protection will be triggered if the over current condition endures more than 200mS. And the switching will be resumed after 16 soft start procedures.

9.3.4 Programmable Switching Frequency

This controller features a programmable switching frequency ranging from 50kHz to 500kHz.

The frequency setting by RON is calculated as below:

$$F_{SW} = \frac{V_{OUT}}{R_{ON}(k\Omega) \times 0.5} (MHz)$$
 (1)

9.3.5 Error Amplifier

The PL86051 has a trans-conductance amplifier and compares the feedback voltage with the internal voltage reference (or the internal soft start voltage during startup phase). The trans-conductance of the error amplifier is 3 mA / V typically. The loop compensation components are required to be placed between the COMP terminal and ground to balance the loop stability and the transient response time.

9.3.6 VCC Regulators

The PL86051 contains two VCC regulators that provide power supply for low side gate driver and boot-strap high side gate drive. One is the NDRV regulator which regulates VCC to 9.5V. The other one is the 10V low dropout LDO powered by EXTVCC which is current limited to 60mA. The VCC load current should be evaluated if NDRV regulator is not used.

9.3.7 Bootstrap Voltage (BST)

The PL86051 has an integrated bootstrap regulator, and requires a small ceramic capacitor between the BST pin and SW pin to provide the gate drive voltage for the high-side FET. The bootstrap capacitor is charged when the BST-SW voltage is below regulation. The value of this ceramic capacitor should be above 100 nF. A ceramic capacitor with an X7R or X5R grade dielectric with a voltage rating of 25 V or higher is recommended because of the stable characteristics over temperature and DC biased voltage.



9.3.8 Thermal Shutdown

A thermal shutdown is implemented to prevent the damage due to the excessive heat and power dissipation. Typically, the thermal shutdown occurs at the junction temperature exceeding 150°C. When the thermal shutdown is triggered, the device stops switching and recover when the junction temperature falls below 130°C.



10 Application and Implementation

10.1 Setting the switching Frequency

The switching frequency of the PL86051 can be programmed as equation 1. For a target switching frequency of 200 kHz, The calculated value is 120 k Ω .

10.2 Setting the Output Current Limit

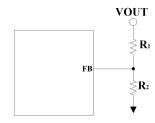
The cycle-by-cycle current limit of the PL86051 is configured by combination of Rocset between OCSET and AGND and sense resistor Rsns in serial with inductor. The cycle-by-cycle current limit is determined as follows:

$$I_{LIML} = \frac{2.4}{R_{OCSET}(k\Omega) \times R_{SNS}(\Omega)} (A)$$
 (2)

10.3 Setting the Output Voltage

Choose R1 and R2 to program the proper output voltage. To minimize the power consumption under light load, it is desirable to choose large resistance values for both R1 and R2. A value between 10k and 1M is recommended for both resistors. If R1=200k is chosen, then R2 can be calculated to be:

$$V_{OUT} = V_{FB} \times \left(1 + \frac{R_1}{R_2}\right) \tag{3}$$



10.4 Selecting the Inductor

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum average input current. The inductance is calculated as:

$$L = \frac{V_{\text{OUT}}}{V_{\text{IN}}} \times \frac{V_{\text{IN}} - V_{\text{OUT}}}{0.4 \times F_{\text{SW}} \times I_{\text{OUT_MAX}}}$$
 (4)

where F_{SW} is the switching frequency and $I_{OUT\ MAX}$ is the maximum load current.

PL86051 is less sensitive to the ripple current variations. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

- 2) The saturation current rating of an inductor must be selected to guarantee an adequate margin to the peak inductor current under full load conditions.
- 3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<10mohm to achieve a good over -all efficiency.

10.5 Selecting the Output Capacitors

The Output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken in to account when selecting these capacitors. For the best performance, it is recommended to use X5R or better grade ceramic capacitor.



10.6 Selecting the Input Capacitors

Multilayer ceramic capacitors are an excellent choice for the input decoupling of the step-down converter as they have extremely low ESR and are available in small footprints. Input capacitors should be located as close as possible to the device. While a 10-µF input capacitor is sufficient for the most applications, larger values may be used to reduce input current ripple.

Take care when using only ceramic input capacitors. When a ceramic capacitor is used at the input and the power is being supplied through long wires, such as from a wall adapter, a load step at the output can induce ringing at the VIN pin. This ringing can couple to the output and be mistaken as loop instability or could even damage the part. Additional "bulk" capacitance (electrolytic or tantalum) in this circumstance, should be placed between CIN and the power source lead to reduce ringing that can occur between the inductance of the power source leads and CIN.

10.7 Selecting the Bootstrap Capacitor

The bootstrap capacitor between the BST and SW pin supplies the gate current to charge the high-side FET device gate during each cycle's turn-on and also supplies charge for the bootstrap capacitor. The recommended value of the bootstrap capacitor is 0.1µF to 1µF. CBST should be a good quality, low ESR, ceramic capacitor located at the pins of the device to minimize potentially damaging voltage transients caused by trace inductance. A value of 0.1µF was selected for this design example.

10.8 Selecting the VCC Capacitors

The primary purpose of the VCC capacitor is to supply the peak transient currents of the driver and bootstrap capacitor as well as provide stability for the VCC regulator. The value of CVCC should be at least 10 times greater than the value of CBST, and should be a good quality, low ESR, ceramic capacitor. CVCC should be placed close to the pins of the IC to minimize potentially damaging voltage transients caused by the trace inductance. A value of 4.7µF was selected for this design example.



10.9 Design Example

The Figure 23 is the typical application schematic for 36 to 60-V input to output 12-V output converter.

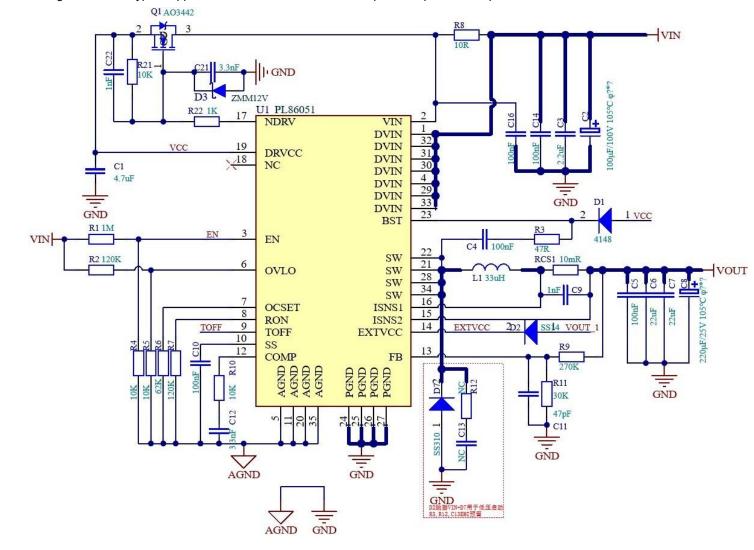
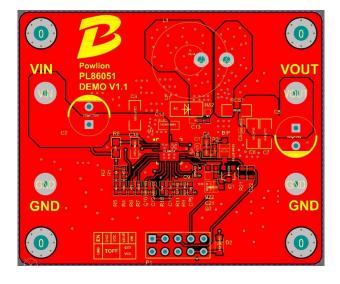


Figure 23. Application Schematic



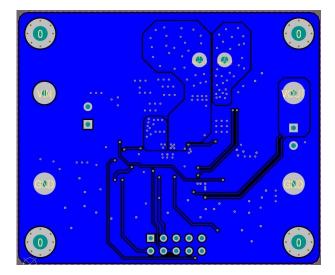
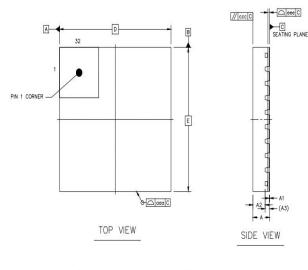
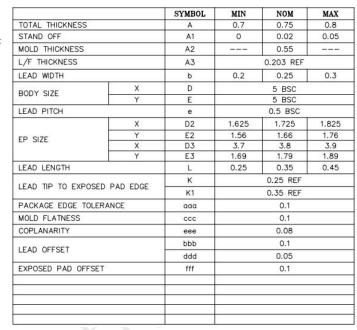


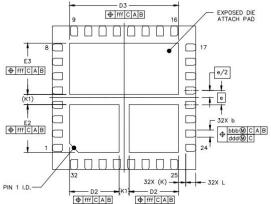
Fig. 24 Top lay Fig. 25 Bottom lay



11 Packaging Information







BOTTOM VIEW

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